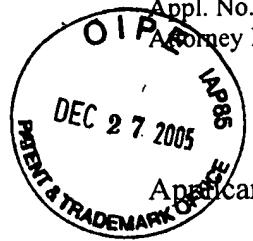


PATENT

Appl. No. 10/681,073

Attorney Docket No. 450134-04839



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : YAZAWA, Kazuaki

Appl. No. : 10/681,073

Filed : October 8, 2003

Title : HEAT DISSIPATING STRUCTURE FOR AN ELECTRONIC DEVICE

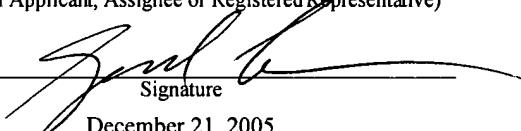
Art Unit : 2835

Examiner : DATSKOVSKIY, Michael V.

745 Fifth Avenue  
New York, NY 10151

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

Samuel S. Lee, Reg. No. 42,791  
(Name of Applicant, Assignee or Registered Representative)



Signature

December 21, 2005

Date of Signature

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of September 13, 2005, please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2.

**Amendments to the Claims** are reflected in the listing of claims, which begins on page 3.

**Remarks/Arguments** begin on page 7.